

N-Ch 200V Fast Switching MOSFET V_{DS}=200V, I_D=1.5A, RDS_(ON)=1000mΩ

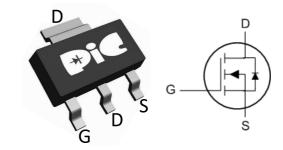
> General Description

This PAN03TB20QB N-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent Rds(On) performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

> Feature

- •Green Device Available
- ■Super Low Gate Charge
- ●Excellent CdV/dt effect decline
- Advanced high cell density Trench technology
- ●SOT-223 package design

> SOT-223



Application

- Motor and Load Control
- Power Management in White LED System
- ●Push Pull Converter
- ●LCD TV Inverter & AD/DC Inverter Systems.

> Absolute Maximum Ratings

Parameter	Symbol	Rating	Units
Drain-Source Voltage	Vos	200	V
Gate-Source Voltage	Vgs	±20	V
Continuous Drain Current, Vos @ 10V1	In@Tc=25°C	1.5	А
Continuous Drain Current, Vgs @ 10V1	In@Tc=100°C	1.3	А
Pulsed Drain Current ₂	Ідм	8	Α
Single Pulse Avalanche Energy₃	EAS	8	mJ
Avalanche Current	las	4	А
Total Power Dissipation4	Pp@Tc=25°C	42	W
Storage Temperature Range	Тѕтс	-55 to 150	°C
Operating Junction Temperature Range	TJ	-55 to 150	°C
Thermal Resistance Junction-ambient (Steady State) ₁	Reja	85	°C/W
Thermal Resistance Junction Case ₁	Rejc	30	°C/W

^{*}Drain current limited by maximum junction temperature

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Electrical Characteristics (T_J=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BVDSS	Vgs=0V , Ip=250uA	200			V
Static Drain-Source On-Resistance2	Rds(on)	Vgs=10V , Ip=1A		0.6	1.0	Ω
	NDS(ON)	Vgs=4.5V , Ip=1A		0.7	1.1	Ω
Gate Threshold Voltage	VGS(th)	Vgs=Vps, Ip =250uA	1.2	2	3	V
Drain-Source Leakage Current	IDSS	Vps=200V , Vgs=0V , TJ=25°C			1	uA
Gate-Source Leakage Current	Igss	V _{GS} =±20V , V _{DS} =0V			±100	nA
Forward Transconductance	gfs	Vps=10V , Ip=1A		10		S
Total Gate Charge (10V)	Qg			15		
Gate-Source Charge	Qgs	Vps=160V , Vgs=10V , Ip=1A		3.0		nC
Gate-Drain Charge	Qgd			5.2		
Turn-On Delay Time	Td(on)			22		
Rise Time	Tr	V_{DD} =100 V , V_{GS} =10 V , R_{G} =3 Ω ,		34		20
Turn-Off Delay Time	Td(off)	ID=1A		45		ns
Fall Time	Tf			11		
Input Capacitance	Ciss			900		
Output Capacitance	Coss	Vps=25V , Vgs=0V , F=1MHz		130		pF
Reverse Transfer Capacitance	Crss			4.6		

Diode Characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous Source Current _{1,6}	Is	V _G =V _D =0V , Force Current			1	Α
Diode Forward Voltage2	VsD	V _G s=0V , I _S =1A , T _J =25°C			1	V
Reverse Recovery Time	trr	IF=1A , di/dt=100A/μs ,		85		nS
Reverse Recovery Charge	Qrr	T _J =25°C		257		nC

Note:

^{1.} Pulse width limited by maximum junction temperature.

^{2.}The data tested by pulsed , pulse width \leqq 300us , duty cycle \leqq 2%

^{3.} The EAS data shows Max. rating . The test condition is V_{DD} =50V, V_{GS} =10V, L=1mH, L_{AS} =4A

^{4.}Ensure that the channel temperature does not exceed 150°C.

^{5.}The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



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> Typical Characteristics

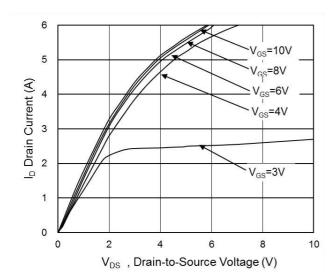


Fig.1 Typical Output Characteristics

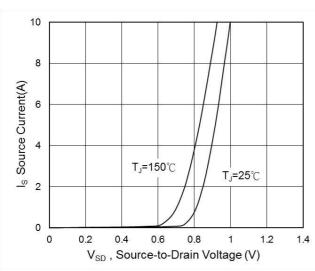


Fig.3 Forward Characteristics of Reverse

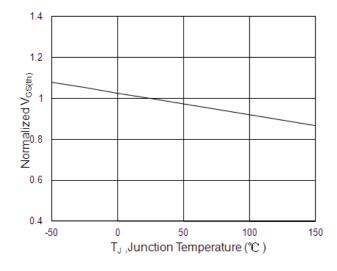


Fig.5 V_{GS(th)} vs. T_J

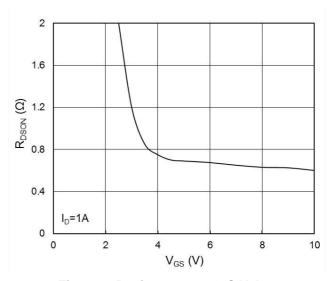


Fig.2 On-Resistance vs. G-S Voltage

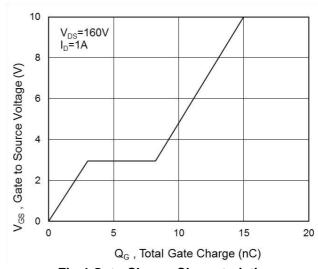


Fig.4 Gate-Charge Characteristics

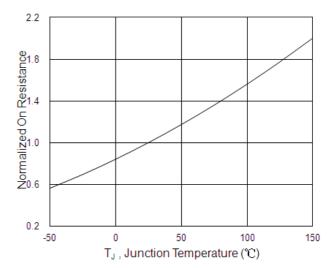


Fig.6 Normalized R_{DSON} vs. T_J



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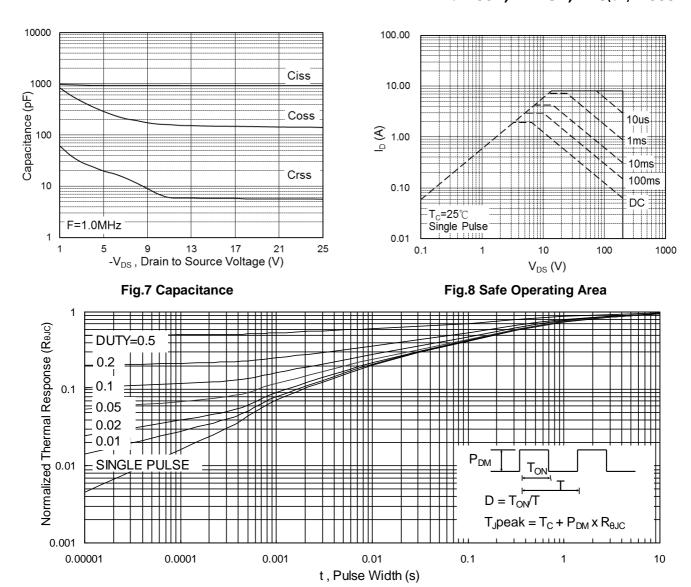


Fig.9 Normalized Maximum Transient Thermal Impedance

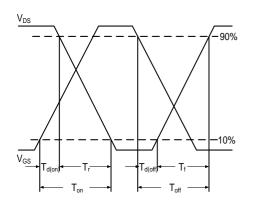


Fig.10 Switching Time Waveform

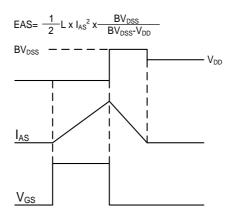


Fig.11 Unclamped Inductive Switching Waveform

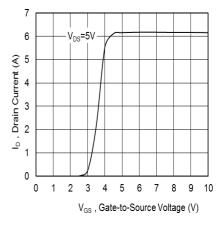
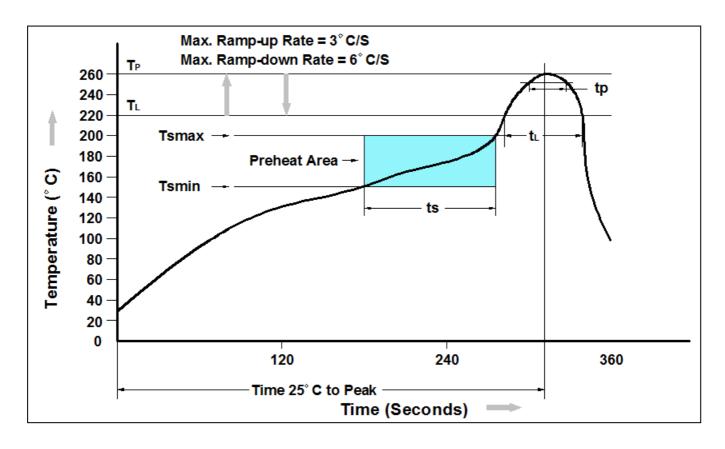


Fig.11 Transfer Characteristics



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Recommand IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Average Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Temperature	260°C +0°C /-5°C
Time (tP) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

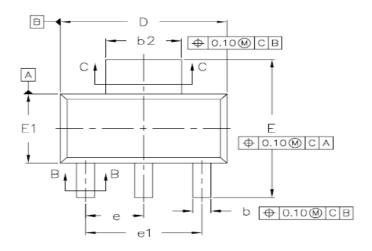
Ordering Information

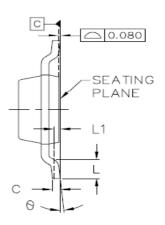
Part Number	Description	Quantity
PAN03TB20QB	SOT-223 Reel	3000 pcs

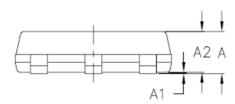


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Package Information (SOT-223)







Ş	\$ COMMON					
MB P	М	М	INCH			
S S	MIN.	MAX.	MIN.	MAX.		
Α		1.80		0.071		
A1	0.02	0.10	0.001	0.004		
A2	1.50	1.70	0.059	0.067		
b	0.66	0.84	0.026	0.033		
b1	0.60	0.79	0.024	0.031		
b2	2.90	3.10	0.114	0.122		
b3	2.84	3.05	0.112	0.120		
С	0.23	0.35	0.009	0.014		
c1	0.23	0.33	0.009	0.013		
D	6.30	6.70	0.248	0.264		
E	6.70	7.30	0.264	0.287		
E1	3.30	3.70	0.130	0.146		
е	2.30 BSC.		0.091	91 BSC.		
e1	4.60 BSC.		0.182	182 BSC.		
L	0.81		0.032			
L1	0.25	0.25 BSC.		0.010 BSC.		
- 9	0,	10°	0,	10°		



PAN03TB20QB

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